

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
Stylesheet Version v1.2

EPAS ID: PAT7077676

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
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EIJI MIZUNO	06/24/2021
TAICHI YAMAGUCHI	06/24/2021
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<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
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<b>DATE SIGNED:</b>	12/16/2021
<b>Total Attachments: 2</b>	
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ASSIGNMENT

WHEREAS I/We **Hiroshi NAKAMURA, Eiji MIZUNO, and Taichi YAMAGUCHI**,  
c/o TBM CO., LTD., 6F, 7-17, Ginza 2-chome, Chuo-ku, Tokyo 1040061 Japan, (hereinafter  
referred to as "ASSIGNOR") has invented certain new and useful improvements in:

**INORGANIC SUBSTANCE POWDER-CONTAINING THERMOPLASTIC RESIN  
COMPOSITION AND FORMED ARTICLE**

which claims priority to JAPAN Application No. 2019-056441, filed March 25, 2019  
and for which I am about to file or have filed an application for Letters Patent of the United  
States;

AND WHEREAS, **TBM CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a  
corporation organized and existing under the laws of the Country of JAPAN, having a place  
of business at, 6F, 7-17, Ginza 2-chome, Chuo-ku, Tokyo 1040061 Japan, is desirous of  
acquiring an interest in the United States and all foreign countries, in and to the said invention  
and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for  
good and valuable consideration, the receipt of which is hereby acknowledged, We, the said  
ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said  
ASSIGNEE, the entire right, title and interest in and to said invention, the applications, and  
any and all patents that may be issued therefrom, in the United States and in all foreign  
countries, including any and all revivals, refilings, continuations, continuations-in part,  
divisions, and reissues thereof, to the said ASSIGNEE; and we, the ASSIGNORS, do hereby  
agree that we will execute all papers necessary in connection with the United States and  
foreign applications when called upon to do so by the said ASSIGNEE, its successors or  
assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and

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cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Hiroshi Nakamura L.S. Date: June 24, 2021  
Hiroshi NAKAMURA

Eiji Mizuno L.S. Date: June 24, 2021  
Eiji MIZUNO

Taichi Yamaguchi L.S. Date: June 24, 2021  
Taichi YAMAGUCHI